Contact Name Title - Contact Phone - Contact* Product-Env-Stewards Authorized Representative* Product-Env-Stewards Product Enviro Compliance Title - Representative Phone - Representative* Product-Env-Stewards Product-Env-Stewards@onsemi.com Requester Item Number Mfr Item Number Mfr Item Name Effective Date Version Manufacturing Site Weight* UOM Un	ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
Company name Company name Company unique ID	752-21.1											als and Mf	fg Informat	ion	
Inter Name Inter Name Inter Contact Inter Representative I	upplier Informa	ation													
Product-Env-Stewards Undorized Representative* Product-Env-Stewards Product Enviro Compliance Product-Env-Stewards	Company name* Company				eany unique ID			Unique ID Authority				Response Date*			
Product Envisor Compliance NA Product Envisor Stewards © onsemi.com NA Product Envisor Stewards © onsemi.com NA Product Envisor Stewards © onsemi.com NA Nanufacturing Site Weight* UOM Un Nanufacturing Proccess Information NA Product Envisor Stewards © onsemi.com NA Nanufacturing Site Nanufact	nsemi											2025-07-18			
Authorized Representative* Product-Env-Stewards Product Enviro Compliance Requester Item Number Requester Item Number Representative* Product Enviro Compliance NA Requester Item Number Representative* Product-Env-Stewards@onsemi.com Na Requester Item Number Representative* Requester Item Number Representative* NA Requester Item Number Representative* Neight* UOM Un Requester Item Number Representative* Requester Item Number Representative* Na Requester Item Number Requester Item Number Representative* Requester Item Number Representative* Neight* UOM Un Requester Item Number Representative* Requester Item Number Request	ontact Name		Title - Contact			1	Phone - Contact*				Email - Contact*				
Product Enviro Compliance Requester Item Number Mfr Item Number Mfr Item Number Mfr Item Name BSS84 FET -50V 10.0 mOhm SOT23 2025-07-18 CN1 Product-Env-Stewards@onsemi.com Manufacturing Site Weight* UOM Un SOT23 Wanufacturing Proccess Information Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Matte Tin (Sn) - annealed CU Alloy 1 Product-Env-Stewards@onsemi.com Manufacturing Site Weight* UOM Un SOT23 CN1 Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow Cycles Seconds Seconds Seconds Seconds Seconds	Product-Env-Stewar	ds		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Requester Item Number	uthorized Represen	tative*	Title - Representative			I	Phone - Representative*			Email - Representative*					
BSS84 FET -50V 10.0 mOhm SOT23 2025-07-18 CN1 9.245 mg Ear	Product-Env-Stewar	ds		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Manufacturing Proccess Information Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow Cycles Matte Tin (Sn) - annealed CU Alloy 1 260 C 30 seconds 3	Requester	Requester Item Number Mfr Item		n Number Mfr Item Name				Effective Date	Version	N	Manufacturing Site	V	Weight*	UOM	Unit Type
Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow Cycles Matte Tin (Sn) - annealed CU Alloy 1 260 C 30 seconds 3		BSS84 FET -50V 10.0 mOhm SO		hm SOT23		2025-07-18		C	CN1		0.245	mg	Each		
Matte Tin (Sn) - annealed CU Alloy 1 260 C 30 seconds 3 comments				erminal Rose	Alloy	STD-020 MSI	Pating	Peak Proc	Pass Rody T	'emperatur	a May Time at Deal	Temperati	ire Numb	per of Reflow Cyc	loc
omments	2 2			·		z Katilig						bei of Kellow Cyc	108		
	•	(Sii) - aimealeu	C	U Anoy	1			200		IC	30	second	18 3		
ver 1 - maximum ume at peak temperature uurmg soutering is 10-50 seconus		no at neak temperature	duning cal	doring is 10 2	A sacands										
or more information regarding material composition please refer to page 3															

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its part provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and/Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.048	mg	Supplier	Silicon (Si)	7440-21-3		0.048	mg
Lead Frame	2.92		В	Nickel (Ni)	7440-02-0		1.06	mg
			Supplier	Iron (Fe)	7439-89-6		1.4658	mg
			Supplier	Copper (Cu)	7440-50-8		0.3942	mg
Mold Compound-Black	6.061		Supplier	Boron zinc hydroxide oxide	138265-88-0		0.1818	mg
			Supplier	Zinc Monoxide (ZnO)	1314-13-2		0.0303	mg
			Supplier	2,4,6-triamino-s-triazincompd.withs-triazine-triol	37640-57-6		0.1818	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		4.8488	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0606	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		0.4849	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.2727	mg
Plating	0.206	mg	Supplier	Tin (Sn)	7440-31-5		0.206	mg
Wire Bond - Cu	0.01	mg	Supplier	Copper (Cu)	7440-50-8		0.01	mg